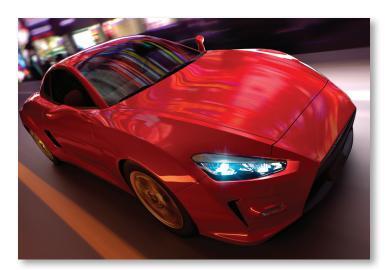


Leaded ROL® 200KR XT™

FOR QFP, SO, SOT AND OTHER LEADED-STYLE APPLICATIONS

The Automotive Test Solution That Drives Toward Higher Test Yields

As a designer of high performance devices for the automotive industry, you know that your applications are growing in both numbers and complexity. Since this trend is expected to continue for the next several years, it is more important than ever to require extreme versatility and superior reliability from your test solutions. Whether you are testing Audio & Infotainment, Vehicle Networking, Powertrain, or other automotive device applications, look for the solution that drives your results toward higher test yields and delivers superior production throughput.



Johnstech's Leaded ROL® 200KR XT^{**} Automotive Contactor is just the product you're looking for! This Xtreme Temperature (XT^{**}) capable product is designed to maximize your test results, regardless of your tri-temp testing objectives! Even if you are not testing outside the temperature limits of standard Contactors and sockets, the robust design of the XT^{**} Contactor provides additional design margin and certainly satisfies even your roadmap requirements.

The Leaded ROL® 200KR XT^{TM} Automotive Contactor improves test yields and increases test reliability through several features, including:

Electrical Reliability Improves Yields

- Patented, One-Piece ROL® Contacts
- Delivers Lowest Contact Resistance (CRES)
- · High current carrying capability
- · Low Inductance
- Extremely stable contact resistance (CRES)
- · High Frequency Capability

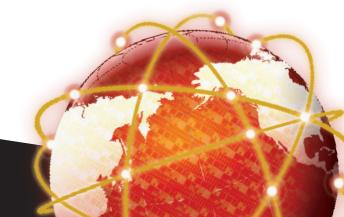
Mechanically Robust

- Long Life ROL® Contacts
- · Temperature Test Stability
- Patented Wiping Lengthens MTBA

Kelvin-Ready™ Versatility

- · Configurable Application Flexibility
- Two Contact Profiles Optimize Performance
- Superior Load Board Design (see back)
- Kelvin Only When And Where Needed
- Determine When To Clean
- Eliminate / Minimize Retests
- Redundant Sense Contact Reliability
- Self Cleaning Contacts Clear Debris

Johnstech®

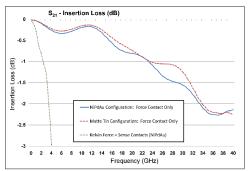


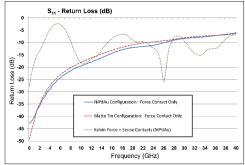
Automotive Leaded ROL® 200KR XT™

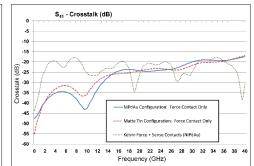
Electrical Specifications	Matte Tin Configuration	NiPdAu Configuration
	Force Contact Only (Force and Sense Contact)	
Inductance:	Self: 0.46 nH (3.09 nH) Mutual: 0.04 nH (0.49 nH)	Self: 0.46 nH (3.26 nH) Mutual: 0.03 nH (0.81 nH)
Capacitance:	Ground: 0.10 pF (0.63 pF) Mutual: 0.02 pF (.118 pF)	Ground: 0.10 pF (0.64 pF) Mutual: 0.02 pF (0.125 pF)
S ₂₁ Insertion Loss (GSG):	-1 dB @ 23.3 GHz (-1 dB @ 1.8 GHz)	-1 dB @ 23.1 GHz (-1 dB @ 2.4 GHz)
S ₁₁ Return Loss (GSG):	-20 dB @ 8.2 GHz (-20 dB @ 0.8 GHz)	-20 dB @ 9.4 GHz (-20 dB @ 0.6 GHz)
S ₄₁ Crosstalk (GSSG):	-20 dB @ 34.7 GHz (-20 dB @ 5.0 GHz)	-20 dB @ 29.9 GHz (-20 dB @ 3.0 GHz)
Average DC Contact Resistance (CRES):	$60 \text{ m}\Omega$ Force Contact $400 \text{ m}\Omega$ Sense Contact	$30~\text{m}\Omega$ Force Contact $330~\text{m}\Omega$ Sense Contact
Current Carrying Capability*: (Duty Cycle 100%, 50%, 1%)	Force Contact 2.8A, 4.1A, 5.9A Sense Contact 1.0A, 1.8A, 2.3A	Force Contact 3.6A, 5.0A, 7.5A Sense Contact 1.0A, 1.8A, 2.3A
Current Leakage:	<1 pA @ 10 V	

Mechanical Specifications	Matte Tin	NiPdAu	
Compressed Height: Electrical Length		1.34 mm 2.00 mm	1.34 mm 2.00 mm
Contact Force (grams): Force (Force + Sense)	@ -65°C @ 25°C @ +175°C	30 grams (70 grams) 30 grams (70 grams) 40 grams (80 grams)	
Contactor Life (# of insertions):		Elastomers = 330,000 Force Contacts = 500,000+ Sense Contacts = 1,000,000+ Housing = 2,200,000+	
Contact Compliance:	0.20 mm		
Contact Wipe on Lead:	0.22 mm	0.13 mm	
Contact Tip Coplanarity:	0.05 mm	0.05 mm	
Temperature:	-65°C to +175°C		
Housing Material:	High Performance Torlon®		
Force Contacts:	Low-Force XL-2K Fine Tip		
Nearest Decoupling Area	1.80 mm		

^{*} Steady state conditions for a 20°C temperature rise. Higher currents allowed for lower duty cycles and higher temperature rises. Force Contact manages test signal current.







Kelvin-Ready™ Load Boards More Reliable, Less Expensive

The Leaded ROL® 200KR load board solution separates the Force and Sense load board traces in a front and back format, allowing standard size load board traces to route test signals. These relatively larger traces maintain testing reliability and simplify load board design, reducing load board manufacturing expenses relative to other socket designs. For I/Os where Kelvin is not needed, removing the Sense line creates additional load board real estate and can also provide a straight line path to high speed connectors when testing RF and other high speed signals.





Spring Pin Side-by-Side Design

Methodology Maroon/White Force White/Gray Sense Elastomers

Johnstech Services and Contact Information

Johnstech Services/Resource Options

Test Floor Technical Support - Worldwide Field Service Offices; First-Pass Yield Enhancement; Performance Audits; Customized Training and Applications Engineering. Online Tech Support at www.johnstech.com/support

Engineering Services

Mobile RF Modeling, Wafer Level Thermal Analysis, Die Shrink Test Planning, Test Signal Integrity Optimization, Test Cell Integration, and Probe Card PCB Evaluation.

Website (www.johnstech.com)

Product, Test, Industry Support Information; Downloadable, Product Spec Sheets; Maintenance and Inspection Guides; Tech Papers and Application Notes.

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